

# Engineering/Process Change Notice

#### ECN/PCN No.: 3919

For Manufacturer						
Product Description: 32.768kHz SMD Crystal	Abracon Part Number / Part Series: IL3X	Documentation only ECN EOL	⊠ Series □ Part Number			
Affected Revision:	New Revision: EOL	Application:	□ Safety ⊠ Non-Safety			
Prior to Change:	1	1				
IL3X Rev. J https://abracon.com/datasheets/ILSI/IL3X	pdf					
After Change: Removal of OE option.						
EOL						
Cause/Reason for Change: Discontinuation of this older product packa	age type and associated manufacturing cap	ability.				
	Change Plan					
Effective Date:	Additional Remarks:					
8/9/2021						
Change Declaration: EOL of glass seal/ceramic cover, transition	to seam seal/metal cover.					
Issued Date:	Issued By:	Issued Department:				
8/9/2021	Stephanie López	Engineering				
Approval: Thomas Culhane	Approval: Reuben Quintanilla	Approval: Ying Huang				
Engineering Director	Quality Director	Purchasing Director				
	For Abracon EOL only					
Last Time Buy (if applicable):	Alternate Part Num	ber / Part Series:				
None	IL3X2					
	https://abracon.com/datasheets/ILSI/IL3X2.pdf		L3X2.pdf			
Additional Approval:	Additional Approval:	Additional Approval:				
	Customer Approval (If Applicable)					
Qualification Status:						
Note: It is considered approved if there is n	□ Approved □ Not accepted o feedback from the customer 1 month afte	er ECN/PCN is released.				
Customer Part Number:	Customer Project:					
Company Name:	Company Representative:	Representative Signature	:			
Customer Remarks:						

Form #7020 | Rev. G | Effective: 02/22/2021 |

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## **IL3X Series**



#### **Product Features:**

±10ppm Tolerance Available Glass Sealed, Ceramic SMD Package Low Profile RoHS Compliant (Exemption 7(c)-I)

#### **Electrical Specifications:**

#### Applications:

Real Time Clock Source Metering Industrial Control Time Reference

Frequency	32.768kHz
Equivalent Series Resistance	65 k Ohms Maximum
Shunt Capacitance (C0)	1.7pF Typ <mark>ical, 2.0pF M</mark> aximum
Frequency Tolerance (at 25°C)	±10ppm or ±20ppm
Frequency Stability (over Temperature)	-0.034ppm/(Cha <mark>nge in °C)2</mark> Typical
Turn over Temperature	25°C ±5°C
Mode of Operation	Fundamental
Crystal Cut	X-Cut (Tuning Fork)
Load Capacitance	6pF, 7pF, 9pF, 12.5pF or Specify
Drive Level	1µWatt Maximum
Aging	±3ppm/Year Maximum
Operating Temperature Range	-40°C to +85°C
Storage Temperature Range	-40°C to +85°C

#### Mechanical and Solder Pad Dimensions:



Part Number Guide Sample Part Number: IL3X – HX5F12.5 – 32.768 kHz						
Package	Frequency Tolerance	Frequency Stability	Operating Temperature Range	Mode of Operations	Load Capacitance	Frequency
IL3X-	J = ±10ppm H = ±20ppm	X = X Cut	5 = -40°C to +85°C	F = Fundamental	6 = 6pF 7 = 7pF 9 = 9pF 12.5 = 12.5pF (or Specify)	- 32.768 kHz

### **IL3X Series**



#### Pb Free Solder Reflow Profile:



Ts max to $T_{L}$ (Ramp-up Rate)	3°C / second max	
Preheat		
Temperature min (Ts min)	150°C	
Temperature typ (Ts typ)	175°C	
Temperature max (Ts max)	200°C	
Time (Ts)	60 to180 seconds	
Ramp-up Rate ( $T_{L}$ to Tp)	3°C / second max	
<u> </u>	5°C / Second max	
Time Maintained Above		
Temperature (T <sub>L</sub> )	217⁰C	
Time (TL)	60 to 150 seconds	
Deak Temperature (Tp)	260°C max for 10	
Peak Temperature (Tp)	seconds	
Time within 5°C to Peak	20 to 40 seconds	
Temperature (Tp)		
Ramp-down Rate	6°C / second max	
Tune 25°C to Peak Temperature	8 minutes max	

Units are backward compatible with +240°C reflow processes

#### Package Information:

MSL = 1 (package does not contain plastic, storage life is unlimited under normal room conditions). Termination = e4 (Au over Ni over W base metallization). Cover: Ceramic Glass Seal

### Tape and Reel Information:



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